

PHOTOCOUPLER PS8101

1 Mbps HIGH CMR ANALOG OUTPUT TYPE 5-PIN SOP PHOTOCOUPLER

-NEPOC Series-

DESCRIPTION

The PS8101 is an optically coupled isolator containing a GaAlAs LED on the light emitting diode (input side) and a PIN photodiode and a high-speed amplifier transistor on the output side on one chip.

This is a plastic SOP (Small Out-line Package) type for high density applications.

FEATURES

- High common mode transient immunity (CMH, CML = $\pm 10 \text{ kV}/\mu \text{s MIN.}$)
- Small package (5-pin SOP)
- High supply voltage (Vcc = 35 V)
- High isolation voltage (BV = 2 500 Vr.m.s.)
- High-speed response (tphL = 0.8 μ s MAX., tpLH = 1.2 μ s MAX.)
- Ordering number of taping product: PS8101-F3, F4: 2 500 pcs/reel
- Pb-Free product
- Safety standards
 - UL approved: File No. E72422
 - DIN EN60747-5-2 (VDE0884 Part2) approved: No. 40008902 (Option)

PIN CONNECTION (Top View) 5 4 3 1. Anode 2. Cathode 3. GND 4. Vo 5. Vcc

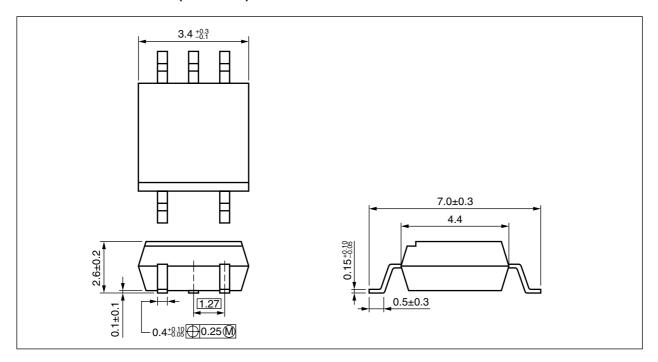
APPLICATIONS

- · Computer and peripheral manufactures
- · General purpose inverter
- Substitutions for relays and pulse transformers
- Power supply

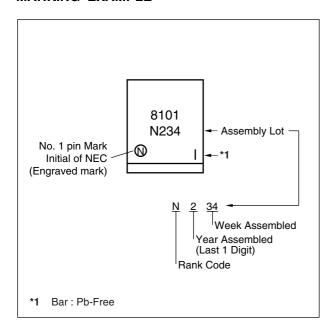
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PACKAGE DIMENSIONS (UNIT: mm)



MARKING EXAMPLE





★ ORDERING INFORMATION

| Part Number | Order Number | Solder Plating Specification | Packing Style | Safety Standard Approval | Application Part Number ¹ |
|-------------|---------------|---------------------------------|------------------------------|-----------------------------|--------------------------------------|
| PS8101 | PS8101-A | Pb-Free | 20 pcs (Tape 20 pcs cut) | Standard products | PS8101 |
| PS8101-F3 | PS8101-F3-A | | Embossed Tape 2 500 pcs/reel | (UL approved) | |
| PS8101-F4 | PS8101-F4-A | | | | |
| PS8101-V | PS8101-V-A | | 20 pcs (Tape 20 pcs cut) | DIN EN60747-5-2 | |
| PS8101-V-F3 | PS8101-V-F3-A | | Embossed Tape 2 500 pcs/reel | (VDE0884 Part2) | |
| PS8101-V-F4 | PS8101-V-F4-A | | | Approved (Option) | |

^{*1} For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

| Parameter | | Symbol | Ratings | Unit |
|---------------------------------|---------------------|--------|-------------|---------|
| Diode | Forward Current | lF | 25 | mA |
| | Reverse Voltage | VR | 5.0 | ٧ |
| | Power Dissipation 1 | P□ | 45 | mW |
| Detector | Supply Voltage | Vcc | 35 | ٧ |
| | Output Voltage | Vo | 35 | ٧ |
| | Output Current | lo | 8.0 | mA |
| | Power Dissipation 2 | Pc | 100 | mW |
| Isolation Voltage ^{*3} | | BV | 2 500 | Vr.m.s. |
| Operating Ambient Temperature | | TA | -55 to +100 | °C |
| Storage Temperature | | Tstg | -55 to +125 | °C |

^{*1} Reduced to 0.45 mW/ $^{\circ}$ C at T_A = 25 $^{\circ}$ C or more.

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^{*2} Reduced to 1.00 mW/ $^{\circ}$ C at T_A = 25 $^{\circ}$ C or more.

^{*3} AC voltage for 1 minute at TA = 25°C, RH = 60% between input and output.

[★] Pins 1-2 shorted together, 3-5 shorted together.



ELECTRICAL CHARACTERISTICS (TA = 25°C)

| Parameter | | Symbol | Conditions | MIN. | TYP. | MAX. | Unit |
|-----------|--|-------------------------|---|------------------|------|------|----------------|
| Diode | Forward Voltage | VF | IF = 16 mA | | 1.7 | 2.2 | V |
| | Reverse Current | lR | V _R = 3 V | | | 10 | μΑ |
| | Forward Voltage Temperature Coefficient | ⊿V F /⊿ T | IF = 16 mA | | -2.1 | | mV/°C |
| | Terminal Capacitance | Ct | V = 0 V, f = 1 MHz | | 30 | | pF |
| Detector | High Level Output Current | Іон (1) | $I_F = 0 \text{ mA}, V_{CC} = V_0 = 5.5 \text{ V}$ | | 3 | 500 | nA |
| | High Level Output Current | Іон (2) | IF = 0 mA, Vcc = Vo = 30 V | | | 100 | μΑ |
| | Low Level Output Voltage | Vol | IF = 16 mA, Vcc = 4.5 V, Io = 1.2 mA | | 0.1 | 0.4 | V |
| | Low Level Supply Current | Iccl | IF = 16 mA, Vo = open, Vcc = 30 V | | 50 | | μΑ |
| | High Level Supply Current | Іссн | IF = 0 mA, Vo = open, Vcc = 30 V | | 0.01 | 2 | |
| Coupled | Current Transfer Ratio [™] | CTR | IF = 16 mA, Vcc = 4.5 V, Vo = 0.4 V | 15 | 20 | 35 | % |
| | Isolation Resistance | R _{I-O} | V _{I-O} = 1 kV _{DC} , RH = 40 to 60% | 10 ¹¹ | | | Ω |
| | Isolation Capacitance | C _{I-O} | V = 0 V, f = 1 MHz | | 0.4 | | pF |
| | Propagation Delay Time $(H \rightarrow L)^{^{12}}$ | tрнL | $I_F = 16 \text{ mA}, \text{ Vcc} = 5 \text{ V}, \text{ RL} = 2.2 \text{ k}\Omega, \\ \text{CL} = 15 \text{ pF}$ | | 0.5 | 0.8 | μs |
| | Propagation Delay Time $(L \rightarrow H)^{^{12}}$ | tрцн | | | 0.6 | 1.2 | |
| | Common Mode Transient Immunity at High Level Output ³ | Смн | $I_F = 0 \text{ mA, } V_{CC} = 5 \text{ V, } R_L = 4.1 \text{ k}\Omega,$ $V_{CM} = 1.5 \text{ kV}$ | 10 | | | kV/ <i>μ</i> s |
| | Common Mode Transient Immunity at Low Level Output ^{*3} | Смь | $I_F = 16 \text{ mA}, \text{ Vcc} = 5 \text{ V}, \text{ RL} = 4.1 \text{ k}\Omega,$ $\text{VcM} = 1.5 \text{ kV}$ | -10 | _ | | |

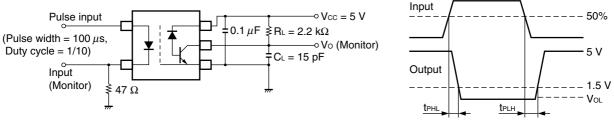
*1 CTR rank

K: 20 to 35 (%) N: 15 to 35 (%)

4

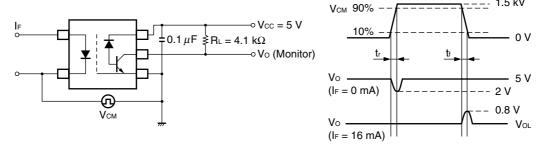


*2 Test circuit for propagation delay time



C_L is approximately 15 pF which includes probe and stray wiring capacitance

*3 Test circuit for common mode transient immunity

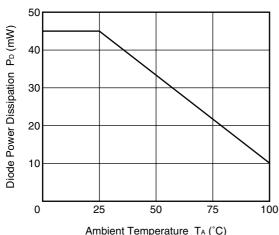


USAGE CAUTIONS

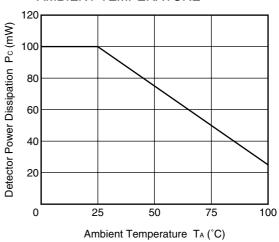
- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. By-pass capacitor of 0.1 μ F is used between Vcc and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
- 3. Avoid storage at a high temperature and high humidity.

TYPICAL CHARACTERISTICS (TA = 25°C, unless otherwise specified)

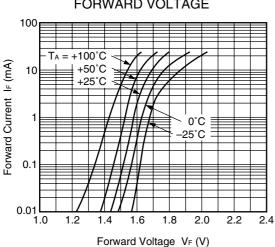




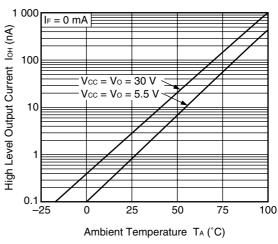
DETECTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



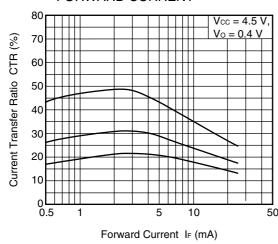
FORWARD CURRENT vs. FORWARD VOLTAGE



HIGH LEVEL OUTPUT CURRENT vs. AMBIENT TEMPERATURE

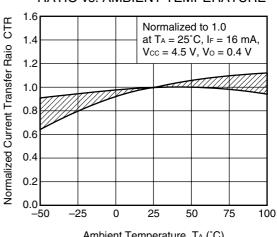


CURRENT TRANSFER RATIO vs. FORWARD CURRENT



Remark The graphs indicate nominal characteristics.

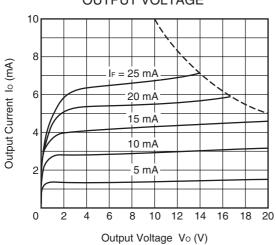
NORMALIZED CURRENT TRANSFER RATIO vs. AMBIENT TEMPERATURE



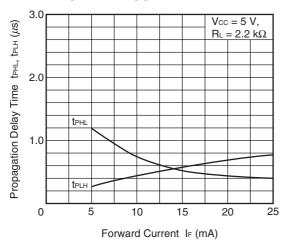
Ambient Temperature TA (°C)



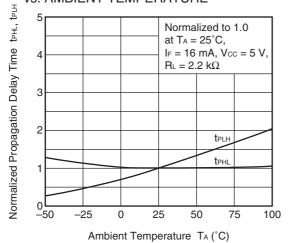
OUTPUT CURRENT vs. OUTPUT VOLTAGE



PROPAGATION DELAY TIME vs. FORWARD CURRENT

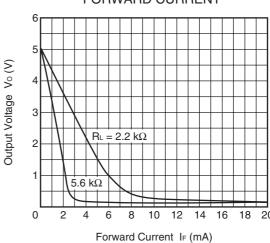


NORMALIZED PROPAGATION DELAY TIME vs. AMBIENT TEMPERATURE

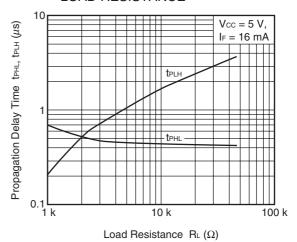


Remark The graphs indicate nominal characteristics.

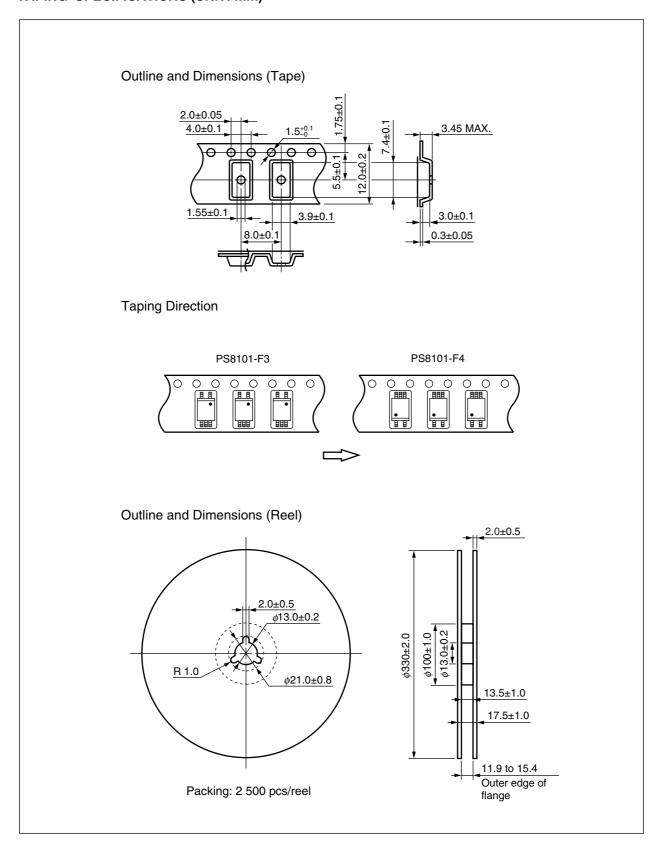
OUTPUT VOLTAGE vs. FORWARD CURRENT



PROPAGATION DELAY TIME vs. LOAD RESISTANCE



TAPING SPECIFICATIONS (UNIT: mm)





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NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

• Peak reflow temperature 260°C or below (package surface temperature)

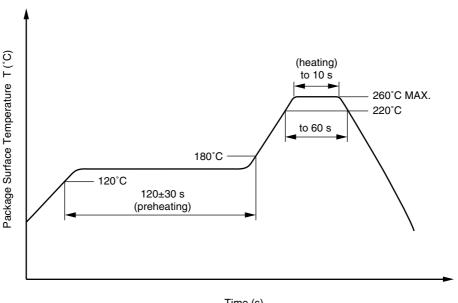
• Time of peak reflow temperature 10 seconds or less • Time of temperature higher than 220°C 60 seconds or less

• Time to preheat temperature from 120 to 180°C 120±30 s

· Number of reflows Three

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

 Temperature 260°C or below (molten solder temperature)

• Time 10 seconds or less

· Preheating conditions 120°C or below (package surface temperature)

· Number of times One (Allowed to be dipped in solder including plastic mold portion.)

• Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine

content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

• Peak Temperature (lead part temperature) 350°C or below • Time (each pins) 3 seconds or less

• Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead

(b) Please be sure that the temperature of the package would not be heated over 100°C



(4) Cautions

• Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

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M8E 00.4-0110

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
 - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

▶ For further information, please contact

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